

2.54mm(.10") Contact Spacing, Smart Card SMT Connectors ECC-CL23 SERIES

FEATURES

- Side to contact IC card.
- No. of contacts: 22, 24, 26 Pin.
- High density SMT package.

SPECIFICATIONS

1.ELECTRICAL

- Voltage rating: 250VAC
- Current rating: 10mA~1A
- Contact resistance: 100mΩ max.
- Insulation resistance: 1000MΩ min.

MATERIALS

1.MATERIAL

- Contacts: Copper Alloy
- Insulator Housing: High Temp. Thermoplastic

2.MECHANICAL

- Durability: Mate & Unmate with applicability for 10000 times, Contact resistance: 100mΩ max.
- Connector Mating Force: 1kgf max.
- Connector Unmating Force: 0.15kgf min. 1kgf max.
- Terminal Retention Force: 0.3kgf min.

2.PLATING

- Nickel In All Area
- Contact Area: Gold over Nickel
- Solder Area: Tin-Lead over Nickel Tin over Nickel (RoHS Compliance)

PACKING

1.Packing method

1-1.All connector are packed in tray method.

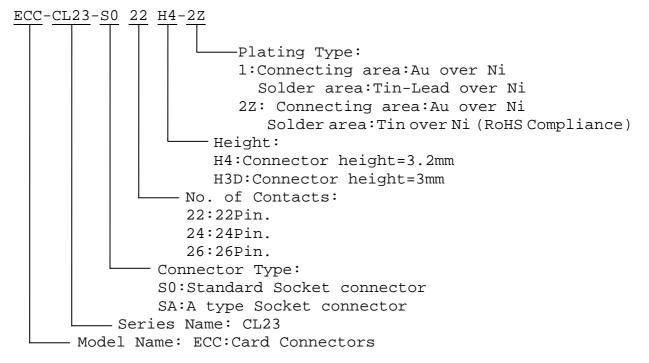
2.Information on label (stuck to each ploy bag, reel and box)

(1)Part NO.(2)Section.(3)Lot NO.(4)Quantity.(5)QC stamp.(6)Reprocess NO.(7)ECE mark.

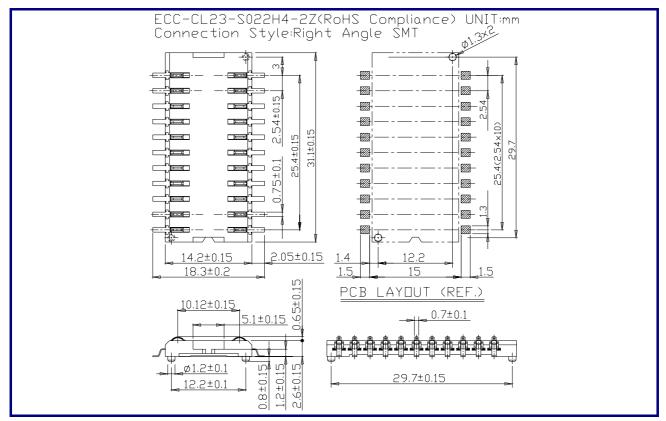




PART NUMBERING SYSTEM



DRAWING

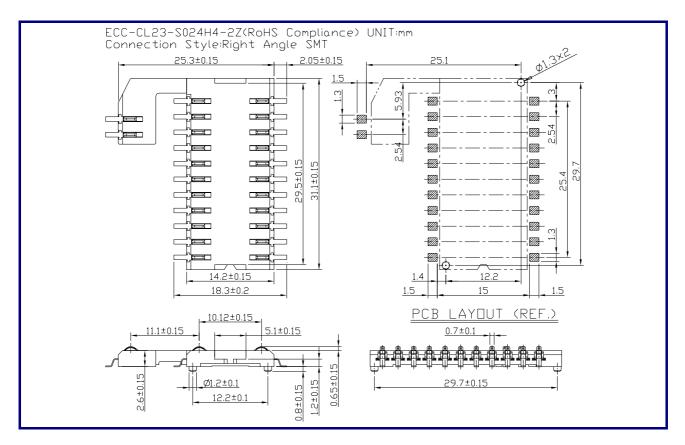


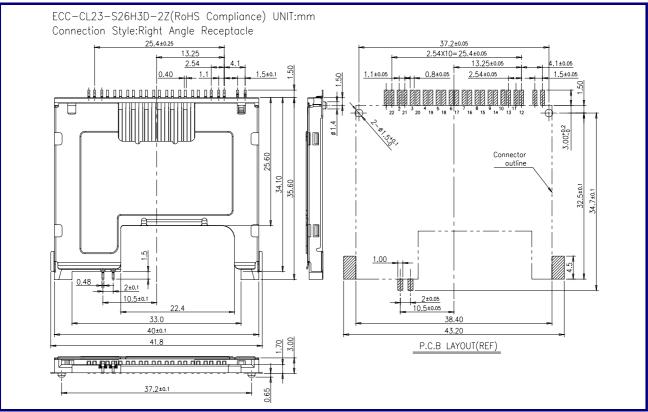
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The Name You Can Trust!

ECE -





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